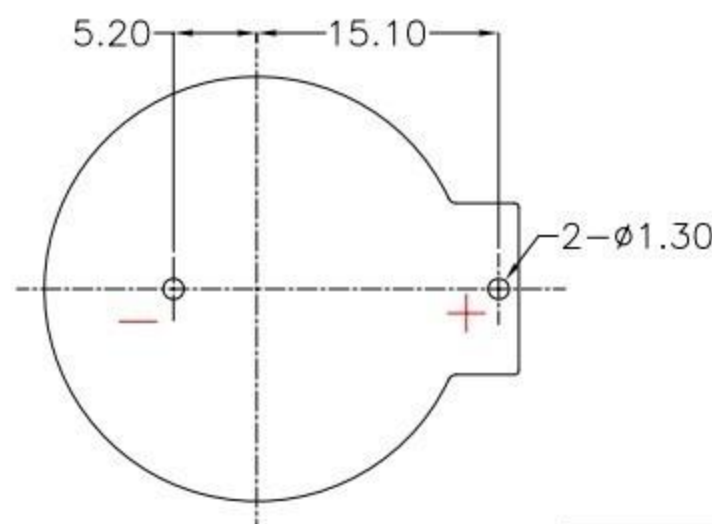
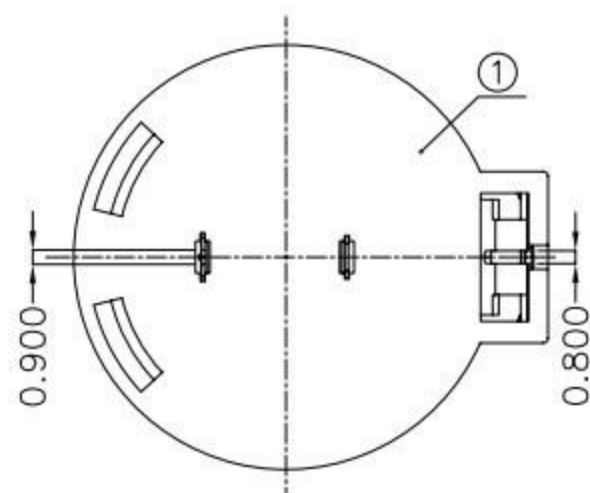
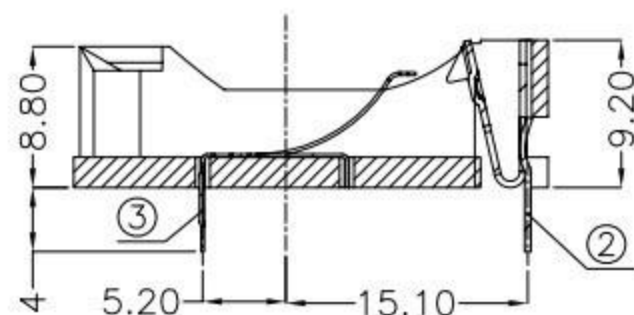
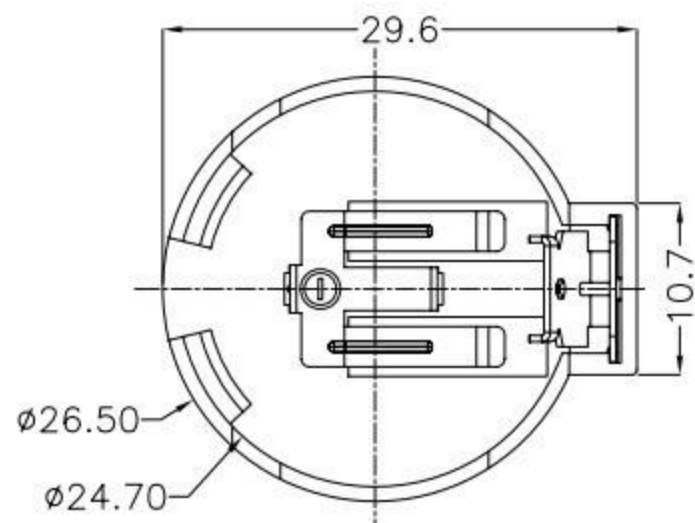




REV.	ECN NO.	REVISED	DATE



PCB Layout Diagram
Top View

NOTE:

1.MATERIAL:

a.HOUSING:PBT

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING: Ni100u"-120u")

SEE ORDERING INFORMATION

2.ELECTRIC:

a.CONTACT RESISTANCE: 30 MILLIOHMS MAX

b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN

c.DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE: -25°C ~ +85°C

ORDERING INFORMATION

电池座系列

DIP 90° TYPE

PLATING:
A-Au1U"
J-Ni100U"~120U"
K-Sn100U"~120U"

MATERIAL:
1A-PBT BLACK
1B-PA66 BLACK
2A-PPA BROWN
2B-PPA BLACK
3A-PPS BROWN
3B-PPS BLACK
4A-LCP WHITE
4B-LCP BLACK

3	TERMINAL(-)	1	PHOSPHOR BRONZE,T=0.20mm	Ni Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE,T=0.40mm	Ni Plating
1	HOUSING	1	PBT	BLACK
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			
DECIMALS:	ANGLES:	DSND	DATE	2017-07-15	TITLE:
X :±0.30	X :±1°	CHKD	DATE	2017-07-15	
X.X :±0.25	X.X :±0.5°	APVD	DATE	2017-07-15	PART NO.:
X.XX :±0.20					
X.XXX :±0.10					
WEIGHT:2.71g		SCALE: 2:1	SIZE: A4	VIEW: ② ③	
SHEET 1 OF 1		UNIT: mm	REV.: A/0	OBJECT: MY	DRAW NO.